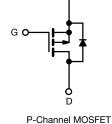
**Vishay Siliconix** 



## **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	-60				
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = -10 V 0.14				
Q <sub>g</sub> max. (nC)	34				
Q <sub>gs</sub> (nC)	9.9				
Q <sub>gd</sub> (nC)	16				
Configuration	Single				





### **FEATURES**

- Dynamic dV/dt rating
- · Repetitive avalanche rated
- P-channel
- 175 °C operating temperature
- Fast switching
- · Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

### DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	IRF9Z34PbF		
Lead (FD)-free	SiHF9Z34-E3		
SnPb	IRF9Z34		
	SiHF9Z34		

<b>ABSOLUTE MAXIMUM RATINGS</b> ( $T_C = 25 \degree C$ , unless otherwise noted)					
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-Source Voltage			V <sub>DS</sub>	-60	v
Gate-Source Voltage			V <sub>GS</sub>	± 20	v
Continuous Drain Current	Vec at 10 V	t -10 V $\frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$ I <sub>D</sub>	1-	-18	
Continuous Drain Current	V <sub>GS</sub> at -10 V	$T_C = 100 \ ^\circ C$	I <sub>D</sub>	-13	А
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	-72	
Linear Derating Factor				0.59	W/°C
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	370	mJ
Repetitive Avalanche Current <sup>a</sup>			I <sub>AR</sub>	-18	A
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	8.8	mJ
Maximum Power Dissipation $T_{C} = 25 \text{ °C}$			PD	88	W
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	-4.5	V/ns
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	
Soldering Recommendations (Peak temperature) <sup>d</sup> for 10 s				300	C
Mounting Torque	6-32 or M3 screw			10	lbf ∙ in
Mounting Torque			-	1.1	N · m

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b.  $V_{DD} = -25 \text{ V}$ , starting  $T_J = 25 \text{ °C}$ , L = 1.3 mH,  $R_g = 25 \Omega$ ,  $I_{AS} = -18 \text{ A}$  (see fig. 12).

c.  $I_{SD} \leq -18$  A, dl/dt  $\leq 170$  A/µs,  $V_{DD} \leq V_{DS}$ ,  $T_J \leq 175$  °C.

d. 1.6 mm from case.

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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62		
Case-to-Sink, Flat, Greased Surface	R <sub>thCS</sub>	0.50	-	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	1.7		

<b>SPECIFICATIONS</b> ( $T_J = 25 \text{ °C}$ , u					TVP	MAX	
PARAMETER	SYMBOL	TEST	CONDITIONS	MIN.	TYP.	MAX.	UNI
Static		1		1	T	[	1
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0$	V, I <sub>D</sub> = -250 μA	-60	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference to	o 25 °C, I <sub>D</sub> = -1 mA	-	-0.060	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_0$	<sub>GS</sub> , I <sub>D</sub> = 250 μΑ	-2.0	-	-4.0	V
Gate-Source Leakage	I <sub>GSS</sub>	V <sub>G</sub>	<sub>S</sub> = ± 20 V	-	-	± 100	nA
		V <sub>DS</sub> = -6	60 V, V <sub>GS</sub> = 0 V	-	-	-100	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = -48 V, V	′ <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C	-	-	-500	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = -10 V	I <sub>D</sub> = -11 A <sup>b</sup>	-	-	0.14	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = -2	5 V, I <sub>D</sub> = -11 A <sup>b</sup>	5.9	-	-	S
Dynamic				1			
Input Capacitance	C <sub>iss</sub>	V	<sub>GS</sub> = 0 V,	-	1100	-	
Output Capacitance	C <sub>oss</sub>		<sub>S</sub> = -25 V,	-	620	-	pF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0 l	MHz, see fig. 5	-	100	-	
Total Gate Charge	Qg			-	-	34	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = -10 V	$I_D = -1 \ 8 \ A,$ $V_{DS} = -48 \ V,$	-	-	9.9	
Gate-Drain Charge	Q <sub>gd</sub>		see fig. 6 and 13 <sup>b</sup>		-	16	1
Turn-On Delay Time	t <sub>d(on)</sub>				18	-	
Rise Time	t <sub>r</sub>	V <sub>DD</sub> = -30 V, I <sub>D</sub> = -18 A,		-	120	-	1
Turn-Off Delay Time	t <sub>d(off)</sub>		= $1.5 \Omega$ , see fig. $10^{\text{b}}$	-	20	-	ns
Fall Time	t <sub>f</sub>	, , , , , , , , , , , , , , , , , , ,		-	58	-	1
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from		-	4.5	-	nH
Internal Source Inductance	L <sub>S</sub>	die contact	die contact		7.5	-	
Gate Input Resistance	Rg	f = 1 MHz, open drain		0.7	-	3.9	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p -n junction diode		-	-	-18	
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			-	-	-72	A
Body Diode Voltage	V <sub>SD</sub>	$T_{\rm J}$ = 25 °C, I <sub>S</sub> = -18 A, V <sub>GS</sub> = 0 V <sup>b</sup>		-	-	-6.3	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			-	100	200	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	- T <sub>J</sub> = 25 °C, I <sub>F</sub> = -18 A, dI/dt = 100 A/µs <sup>b</sup>		-	0.28	0.52	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-	-on time is negligible (turr	1-on is do	minated b	v Le and	Ln)

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

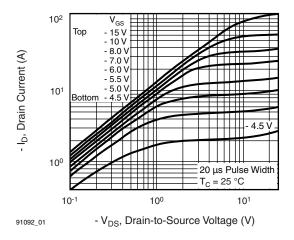
b. Pulse width  $\leq 300~\mu s;~duty~cycle \leq 2~\%.$ 

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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





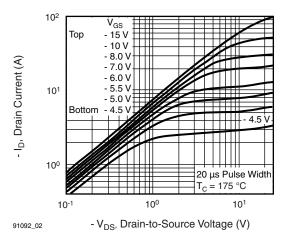
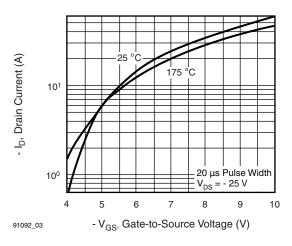


Fig. 2 - Typical Output Characteristics,  $T_C = 175 \ ^\circ C$ 





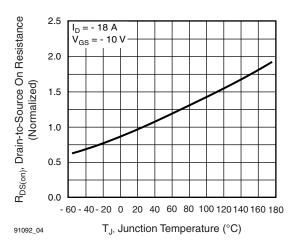


Fig. 4 - Normalized On-Resistance vs. Temperature

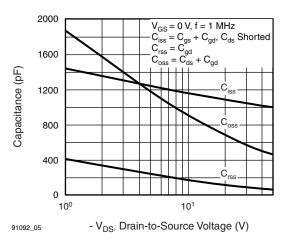


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

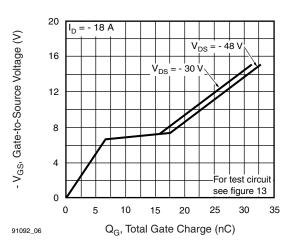


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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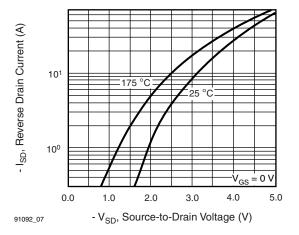


Fig. 7 - Typical Source-Drain Diode Forward Voltage

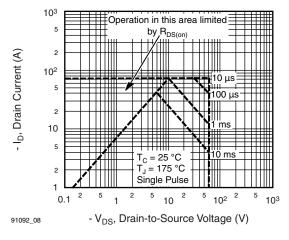


Fig. 8 - Maximum Safe Operating Area

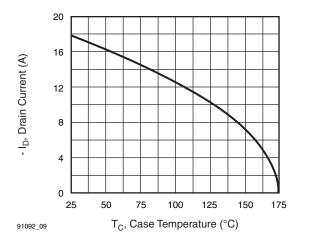


Fig. 9 - Maximum Drain Current vs. Case Temperature

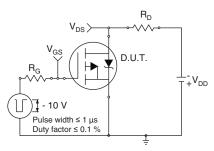


Fig. 10a - Switching Time Test Circuit

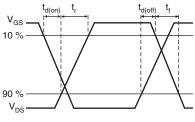
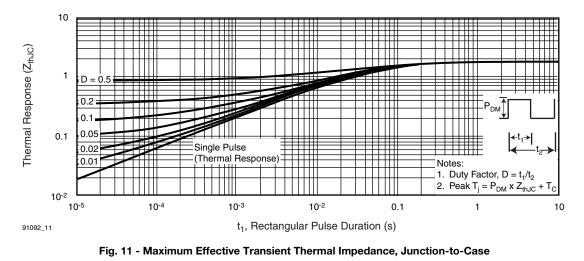


Fig. 10b - Switching Time Waveforms



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### IRF9Z34, SiHF9Z34

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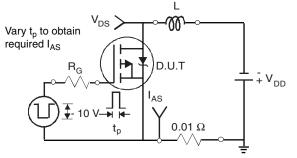
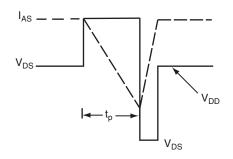


Fig. 12a - Unclamped Inductive Test Circuit



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Fig. 12b - Unclamped Inductive Waveforms

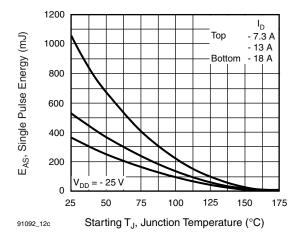


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

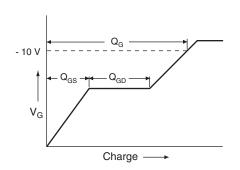


Fig. 13a - Basic Gate Charge Waveform

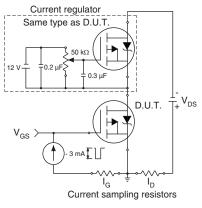


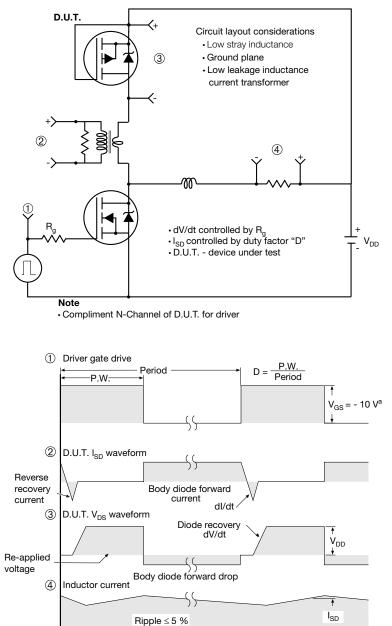
Fig. 13b - Gate Charge Test Circuit

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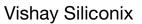
### Peak Diode Recovery dV/dt Test Circuit



Note a. V<sub>GS</sub> = - 5 V for logic level and - 3 V drive devices

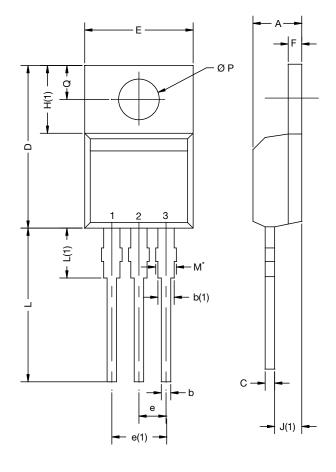
Fig. 14 - For P-Channel

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TO-220-1



DIM.	MILLIN	MILLIMETERS		INCHES	
DIN.	MIN.	MAX.	MIN.	MAX.	
А	4.24	4.65	0.167	0.183	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.78	0.045	0.070	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
E	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.10	6.71	0.240	0.264	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØР	3.53	3.94	0.139	0.155	
Q	2.54	3.00	0.100	0.118	
ECN: X15-0364-Rev. C, 14-Dec-15 DWG: 6031					

Note

-  $M^{\star}$  = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM

Package Picture				
AS	ASE		'an	
		IRF 9510 744K AB		

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